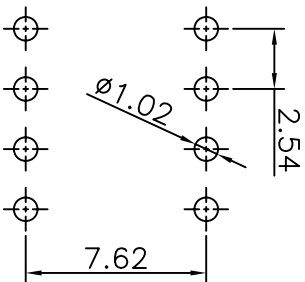
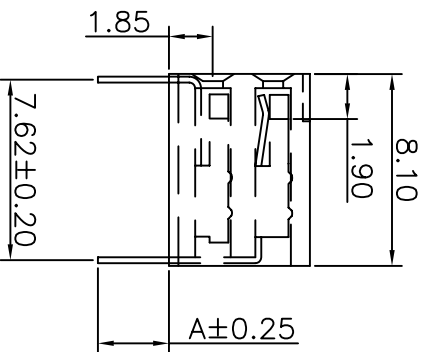
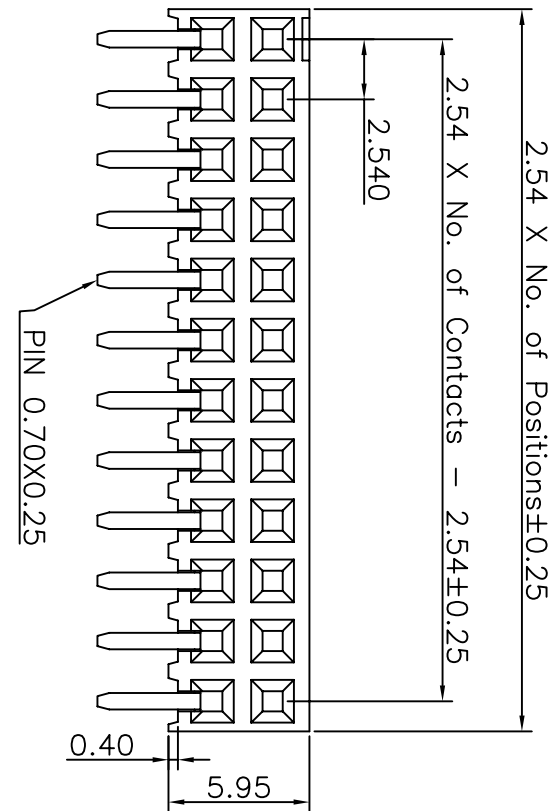


Recommended PC Board Layout



SPECIFICATIONS:

1. Current Rating: 3Amp
2. Insulation Resistance: 1000MΩ Min.
3. Dielectric Withstanding: 600V AC/DC
4. Contact Resistance: 20mΩ Max.
5. Operating Temperature: -40°C to +105°C
6. Contact Material: Copper Alloy
7. Insulation Material: Polyester, UL 94V-0
8. Plating: Gold, Tin or Selective over Nickel
9. Solderability: IR Reflow 260°C for 10sec
Wave 230°C for 5~10sec
Manual solder 350°C for 3~5sec



How to order

FEDB04-X X X X X X
1 2 3 4 5 6

1. Series No
2. No. Of Pin Per Row
3. Contact Plating
G1=Gold flash
T1=Tin
S1=Gold/tin
4. Pin Length
XXX=Select A
001=(A=3.0)
5. Insulator Material
T=Nylon 6T *
L=LCP
6. Packing
C=Tube *

* for standard



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Email: info@rsk-tech.com

TITLE: Female Header, 2.54 Pitch, Dual row,
R/A Type, Side Entry, W=7.62

A4

APPD.: Xiao Jian

PART NO.: FEDB04-XXXX

CHKD.: Wang Zhijun

DWG. NO.: FEDB04-XXXX

DR.: Li Guoming

REV.: 1.0 DATE: 2006-05-14

X: ±0.30 Y: ±5.0°

XX: ±0.20 XX: ±3.0°

XXX: ±0.15 XXX: ±1.0°

UNIT: mm

SCALE: 1:1 SHEET: 1/1

| | | | |
|-----|----------|-------|------------|
| 1.3 | | | |
| 1.2 | | | |
| 1.1 | | | |
| 1.0 | RELEASED | Li GM | 2006-05-14 |
| REV | ECN, ND. | DR.BY | DATE |

| | | | | | | | |
|---|---|---|---|---|---|---|---|
| 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 |
|---|---|---|---|---|---|---|---|